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FGH60T65SHD 650 V, 60 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature : T_J =175^oC
- · Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} =1.6 V(Typ.) @ I_C = 60 A
- + 100% of the Parts Tested for $I_{\text{LM}}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- RoHS Compliant

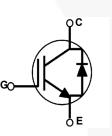
General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	I Description		FGH60T65SHD_F155	Unit
V _{CES}	Collector to Emitter Voltage		650	V
M	Gate to Emitter Voltage		± 20	V
V _{GES}	Transient Gate to Emitter Voltage		± 30	V
	Collector Current	@ T _C = 25 ^o C	120	А
I _C	Collector Current	@ T _C = 100°C	60	А
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	180	А
I _{CM (2)}	Pulsed Collector Current		180	А
I _F	Diode Forward Current	@ T _C = 25°C	60	А
۰F	Diode Forward Current	@ T _C = 100 ^o C	30	А
I _{FM (2)}	Pulsed Diode Maximum Forward Currer	180	А	
P _D	Maximum Power Dissipation	@ T _C = 25°C	349	W
	Maximum Power Dissipation	@ T _C = 100°C	174	W
TJ	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} =180 A, R_{G} = 27 $\Omega,$ Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

August 2015

Thermal Characteristics

Symbol	Parameter	FGH60T65SHD_F155	Unit	
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.43	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.25	°C/W	
R _{θJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantit
FGH60T65SHD_F155	FGH60T65SHD	TO-247 G03	Tube	-	-	30

Electrical Characteristics of the IGBT $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 1 mA	650	-	-	V
ΔBV _{CES} / ΔT _J	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 60 mA, V _{CE} = V _{GE}	4.0	5.5	7.5	V
- (- /	, , , , , , , , , , , , , , , , , , ,	I _C = 60 A, V _{GE} = 15 V	-	1.6	2.1	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 60 A, V _{GE} = 15 V, T _C = 175°C	-	2.14	-	V
Dynamic C	Characteristics				•	
C _{ies}	Input Capacitance		-	2980	-	pF
C _{oes}	Output Capacitance	V _{CE} = 30 V _, V _{GE} = 0 V, f = 1MHz	-	110	-	pF
C _{res}	Reverse Transfer Capacitance		-	36	-	pF
Switching	Characteristics	•			•	
t _{d(on)}	Turn-On Delay Time			26	-	ns
t _r	Rise Time		-	48	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 60 A,	-	87	- 1	ns
t _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	47	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	1.69	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.63	-	mJ
E _{ts}	Total Switching Loss		-	2.32	- /	mJ
t _{d(on)}	Turn-On Delay Time		-	25		ns
t _r	Rise Time	V_{CC} = 400 V, I _C = 60 A, R _G = 6 Ω, V _{GE} = 15 V, Inductive Load, T _C = 175 ^o C	-	60	-	ns
t _{d(off)}	Turn-Off Delay Time		-	93	-	ns
t _f	Fall Time		-	72	-	ns
4			-	2.54	-	mJ
	Turn-On Switching Loss					1110
E _{on}	Turn-On Switching Loss Turn-Off Switching Loss		-	1.04	-	mJ

Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	102	-	nC
Q _{ge}	Gate to Emitter Charge		-	18.4	-	nC
Q _{gc}	Gate to Collector Charge		-	37.5	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 30 A	T _C = 25°C	-	2.3	2.7	V
*FM	blode i olivara voltage	1F - 30 A	T _C = 175 ^o C	-	1.9	-	
E _{rec}	Reverse Recovery Energy		T _C = 175 ^o C	-	50	-	uJ
t _{rr}	Diode Reverse Recovery Time	I _F =30 A, dI _F /dt = 200 A/μs	T _C = 25 ^o C		34.6	-	ns
		ΓF = 50 Λ, αιρίαι = 200 Λίμο	T _C = 175 ^o C	-	197	-	
Q _{rr}	Q _{rr} Diode Reverse Recovery Charge		T _C = 25 ^o C	-	58.6	-	nC
~"	2.000 Hororor Roborory Charge		T _C = 175 ^o C	-	810	-	

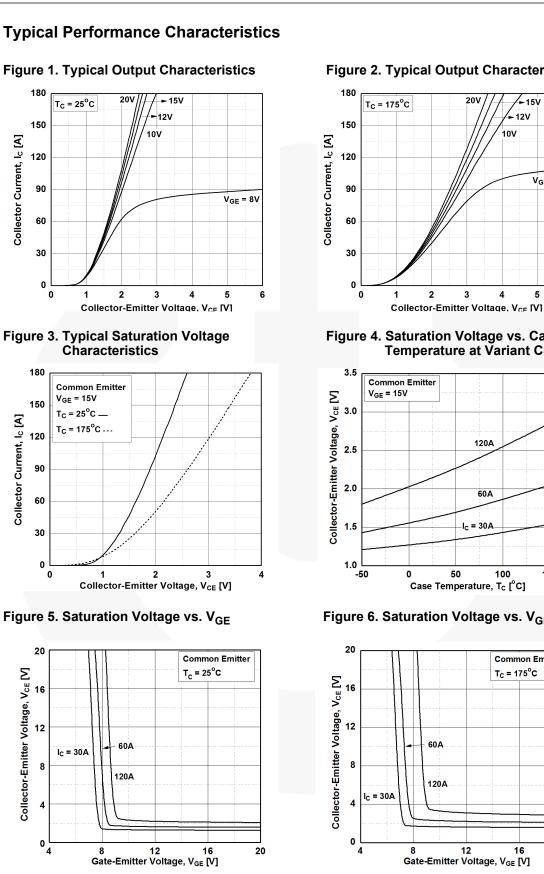


Figure 2. Typical Output Characteristics

20V

-15V

V_{GE} = 8V

12V

10V

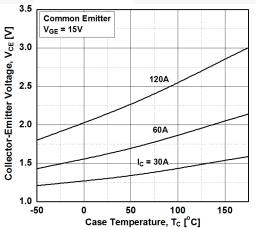


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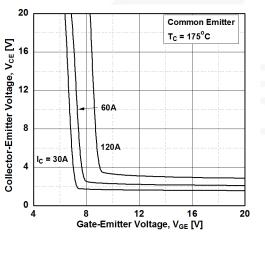
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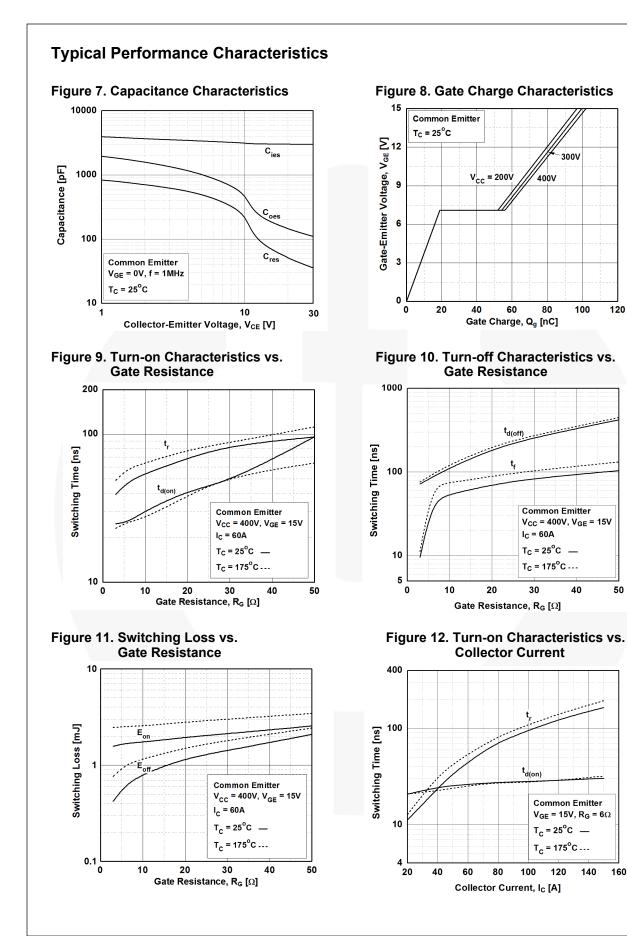




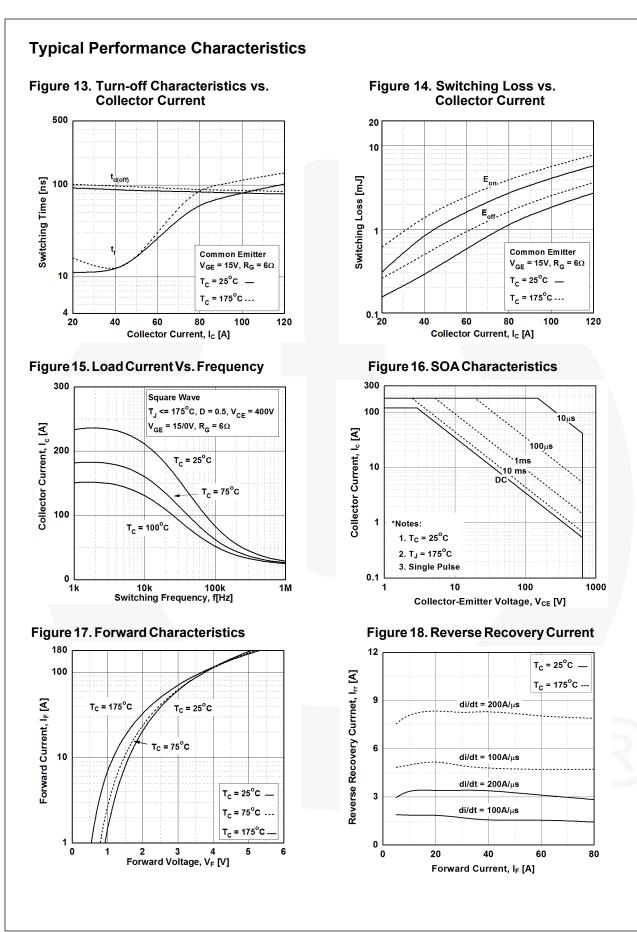


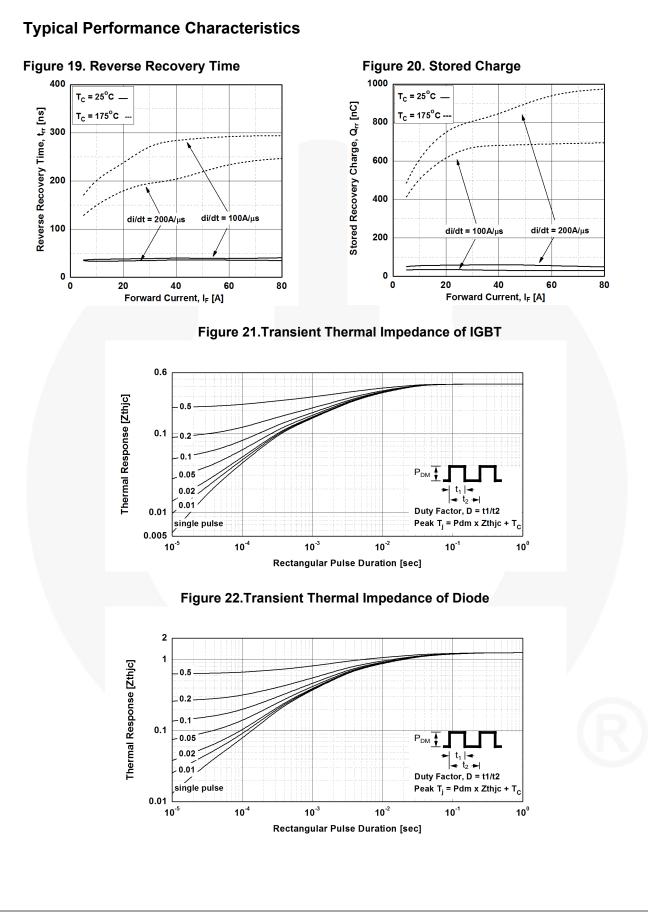
Collector Current, I_c [A]

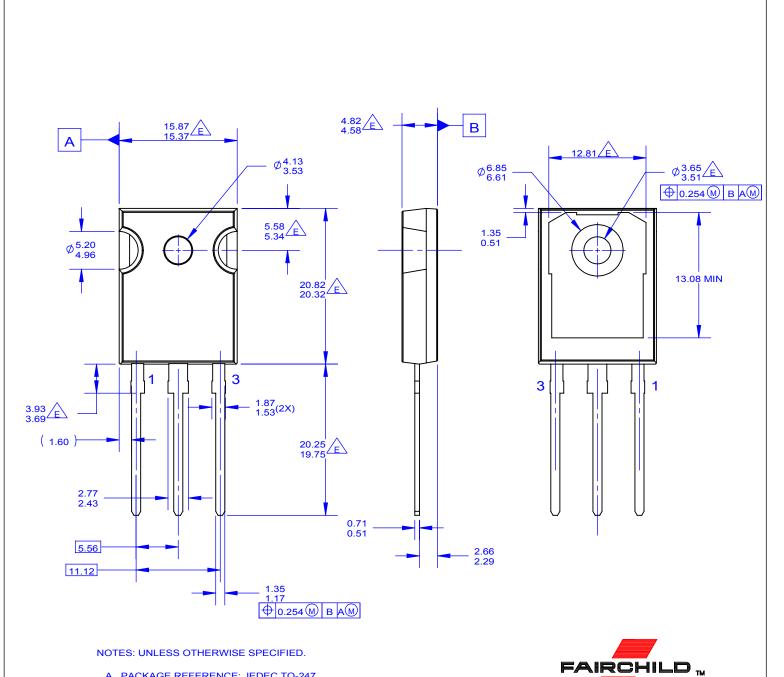
Collector Current, I_c [A]



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